



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

March 24, 2005

In re the application of:

Seungbae Park et al.

Docket No. EN999048D

Filed: 03/27/2003

Art Unit: 1742

Serial No.: 10/038,264

Examiner: Ernesto Garcia

For: Solder interconnect techniques

Confirmation No. 8328

SUPPLEMENTAL AMENDMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In further response to the Office Action dated July 29, 2004, identified as Paper No. 20040719, the notice of non-compliant amendment dated March 3, 2005, identified as Paper No. 20050225, and the amendment filed November 29, 2004, please consider the following supplemental amendment and remarks.

Amendments to the Claims begin on page 3 of this paper.

Remarks/Arguments begin on page 7 of this paper.